TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIV)

TPCS8303

Lithium Ion Battery Applications
Notebook PC Applications
Portable Machines and Tools

- Small footprint due to small and thin package
- Low drain-source ON resistance: $RDS(ON) = 15 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 18 \text{ S (typ.)}$
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -20 V)$
- Enhancement mode: V_{th} = -0.45~-1.2 V (V_{DS} = -10 V, I_D = -200 μA)

Absolute Maximum Ratings (Ta = 25°C)

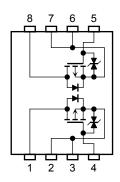
Char	acteristics	Symbol	Rating	Unit	
Drain-source vol	tage	V_{DSS}	-20	V	
Drain-gate voltag	ge (R _{GS} = 20 kΩ)	V _{DGR}	-20	V	
Gate-source volt	age	V _{GSS}	±12	V	
Drain current	DC (Note 1)	I _D	-5	Α	
Diain current	Pulse (Note 1)	I _{DP}	-20	A	
Drain power	Single-device operation (Note 3a)	P _{D (1)}	1.1	W	
dissipation (t = 10 s) (Note 2a)	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.75		
Drain power dissipation (t = 10 s) (Note 2b)	Single-device operation (Note 3a)	P _{D (1)}	0.6	W	
	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.35		
Single pulse avalanche energy (Note 4)		E _{AS}	16.3	mJ	
Avalanche current		I _{AR}	-5	Α	
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5)		E _{AR}	0.075	mJ	
Channel temperature		T _{ch}	150	°C	
Storage tempera	ture range	T _{stg}	-55~150	°C	

Weight: 0.035 g (typ.)

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Circuit Configuration

2-3R1E



Note: (Note 1), (Note 2), (Note 3), (Note 4), (Note 5): See the next page.

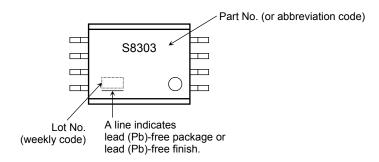
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

Thermal Characteristics

Characteristics	Symbol	Max	Unit		
The sweet was interest about a lite and in the	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	114	°C/W	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	Single-device value at dual operation (Note 3b)	R _{th} (ch-a) (2)	167		
Thermal registeres, channel to embient	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	208		
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	357	°C/W	

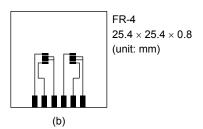
Marking (Note 6)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:

- a) Device mounted on a glass-epoxy board (a)
 - FR-4 25.4 × 25.4 × 0.8 (unit: mm)
- b) Device mounted on a glass-epoxy board (b)



Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device (During dual operation, power is evenly applied to both devices.)
- Note 4: $V_{DD} = -16$ V, $T_{ch} = 25$ °C, $L = 500 \,\mu$ H, $I_{AR} = -5$ A, $R_G = 25 \,\Omega$
- Note 5: Repetitive rating: pulse width limited by max channel temperature
- Note 6: o n lower right of the marking indicates Pin 1.



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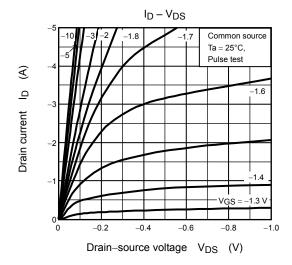
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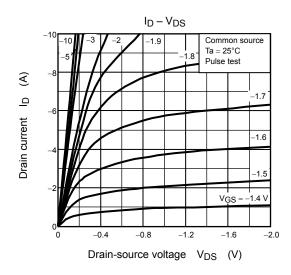
Electrical Characteristics (Ta = 25°C)

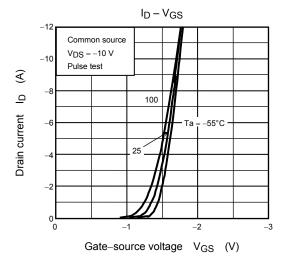
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	Sate leakage current		$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	Drain cut-OFF current		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μΑ
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_		V
		V _{(BR) DSX}	$I_D = -10 \text{ mA}, V_{GS} = 12 \text{ V}$	-8	_	_	V
Gate threshold ve	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.45	_	-1.2	>
			$V_{GS} = -2.0 \text{ V}, I_D = -2.5 \text{ A}$	_	31	80	mΩ
Drain-source ON	resistance	R _{DS} (ON)	$V_{GS} = -2.5 \text{ V}, I_D = -2.5 \text{ A}$	_	22	30	
			$V_{GS} = -4.5 \text{ V}, I_D = -2.5 \text{ A}$	_	15	21	
Forward transfer	Forward transfer admittance		$V_{DS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	9	18	_	S
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	2560	_	pF
Reverse transfer	Reverse transfer capacitance			_	330	_	
Output capacitance		Coss		_	380	_	
Switching time	Rise time	t _r	VGS -5 V ID = -2.5 A C Y ID = -2.5 A	_	5	_	
	Turn-ON time	t _{on}		_	14	_	ns
	Fall time	t _f		_	42	_	
	Turn-OFF time	t _{off}	$V_{DD} \simeq -10 \text{ V}$ Duty ≤ 1%, $t_W = 10 \text{ μs}$	_	142	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	33	_	
Gate-source charge 1		Q _{gs}	$V_{DD} \simeq -16 \text{ V,V}_{GS} = -5 \text{ V, I}_{D} = -5 \text{ A}$	_	10	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	5.4	_	

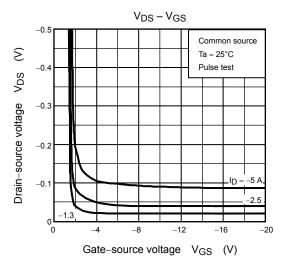
Source-Drain Ratings and Characteristics (Ta = 25°C)

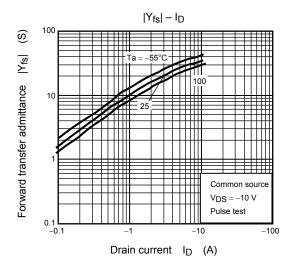
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-20	Α
Forward voltage (diode)		V _{DSF}	$I_{DR} = -5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

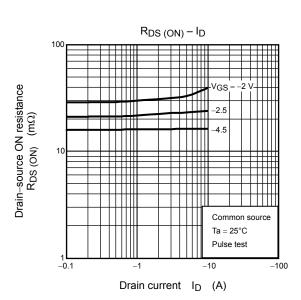


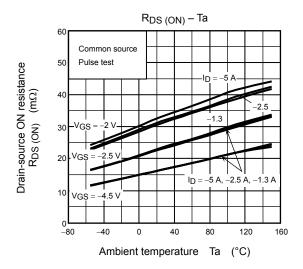


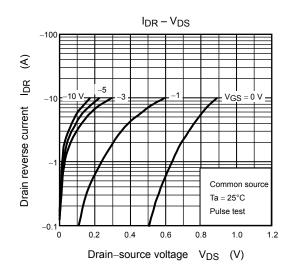


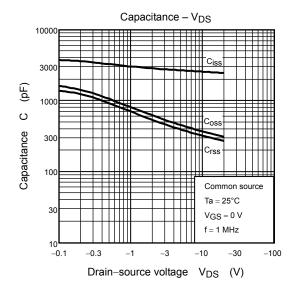


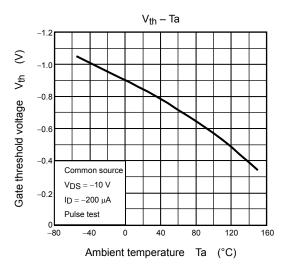


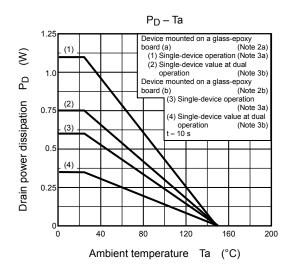


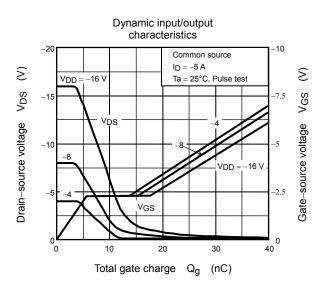




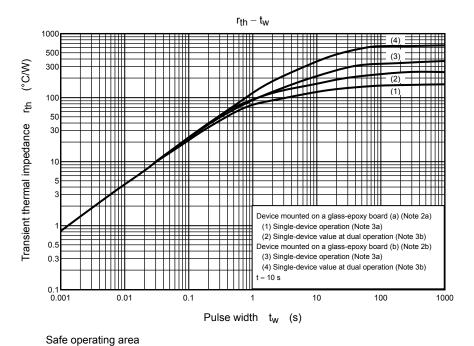




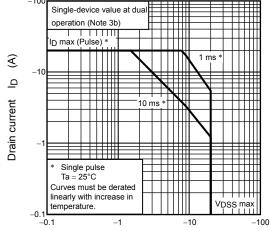




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Drain–source voltage $\ V_{DS}\ (V)$

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